

## Memorandum of Understanding (MoU)

### **Between**

#### **Forge Alumnus Services Pvt. Ltd**

Level 6, N Heights, Hi-Tech City,  
Hyderabad, Telangana-500081

### **And**

#### **CMR Technical Campus**

HFXP+4JH, Kandlakoya, Kandlakoya Village,  
Medchal Rd, near by Nehru Outer Ring Road,  
EXIT 6, Hyderabad, Telangana 501401

MoU#: CMRTC 01-001

### **1. Parties to the MOU**

This Memorandum of Understanding (MoU) is entered into on the **03<sup>rd</sup> day of January 2026**

#### **Between:**

**Forge Alumnus Services Pvt. Ltd.**, a career discovery and development organization, hereinafter referred to as “**Forge Alumnus**”, having its registered office at **Level 6, N Heights, Hi-Tech City, Hyderabad, Telangana-500081**.

### **And**

**CMR Technical Campus**, an engineering institution, hereinafter referred to as “the Institution”, having its campus at HFXP+4JH, Kandlakoya, Kandlakoya Village, Medchal Rd, near by Nehru Outer Ring Road, EXIT 6, Hyderabad, Telangana 501401.

**Forge Alumnus and the Institution are hereinafter collectively referred to as “the Parties” and individually as “a Party.”**

### **2. Purpose of the MOU**

The purpose of this MoU is to establish a collaborative framework to implement a **Hackathon-Centric Career Discovery & Development Program** for **First and Second-Year Engineering Students**, aimed at:

- Enabling early career awareness and direction among students.
- Strengthening technical competencies through hackathons, codeathons, and workshops.
- Enhancing professional readiness via mentoring and industry networking.
- Providing measurable analytics and insights to support institutional training and placement initiatives through a unified digital ecosystem.

### **3. Scope of Collaboration**

Under this MoU, **Forge Alumnus** shall design, deploy, and manage a structured career discovery and development program consisting of academic-year-long activities supported by a digital platform.

### **4. Program Components**

The program shall include, but not be limited to, the following components:

#### **4.1 Academic & Technical Engagement**

##### **Codeathons:**

- Domain-specific challenges
- Frequency: 1 per academic year

##### **Hackathons:**

- Company simulation or domain-based challenges
- Frequency: 1 per academic year

##### **Technical Workshops:**

- Hands-on workshops on emerging technologies (AI, IoT, Cloud, Data, etc.)
- Frequency: 2 per academic year

#### **4.2 Professional Exposure & Assessment**

##### **Professional Networking Sessions:**

- Monthly interactions with industry professionals and mentors
- Frequency: Up to 5 sessions per academic year

##### **Assessments & Feedback:**

- Aptitude, technical, and communication skill assessments
- Frequency: 2 per academic year

#### **4.3 Digital Tools & Continuous Access**

- AI-powered Resume Builder and Digital Portfolio Tool
- Hackathon hosting and analytics platform
- Live student leaderboards based on participation and skill growth
- Weekly internship updates curated by skill relevance
- Real-time event notifications (college, corporate, and student-driven)
- Free access to eligible/selected skill development courses

#### **5. Digital Ecosystem Access**

Forge Alumnus shall provide access to its digital platform for registered users, including:

##### **5.1 College Dashboard:**

Analytics and reports for Placement Cell, Training & Development, and Academic Departments

##### **5.2 Student Dashboard:**

Personalized access to learning resources, events, assessments, and career tracking

#### **6. Roles and Responsibilities**

##### **6.1 Responsibilities of Forge Alumnus**

- Design and deliver hackathons, codeathons, workshops, and networking sessions.
- Provide and maintain access to the Forge Alumnus digital platform.
- Share analytics, participation reports, and outcome-based insights with the Institution.
- Coordinate with institutional stakeholders for scheduling and execution.

##### **6.2 Responsibilities of the Institution**

- Nominate a Single Point of Contact (SPOC) for program coordination.
- Facilitate student onboarding, communication, and participation.
- Provide necessary infrastructure (venue, internet, student coordination) for on-campus events.
- Encourage participation from First and Second-Year students as per agreed scope.



| Role                 | Description  | Appointed Person<br>(if blank, role is not applicable)   |
|----------------------|--|--|
| Relationship Manager | <p>Single point of contact for Forge's team. Manages specifications and advises the delivery team on changes required and for all business, financial, and relationship matters.</p> <p>Accepts/approves and signs off work completed at each stage.</p> | <p><b>For Forge:</b> SREELU EDLA</p> <p><b>Email:</b> SREELU.EDLA@FORGEALUMNUS.COM</p> <p><b>Mobile:</b> 8374-714808</p> <p><b>For client:</b> DR. N. BASAKAR</p> <p><b>Email:</b> MOD.CSE1@CMRTC.AC.IN</p> <p><b>Mobile:</b> 8464925680</p> |

## 7. Benefits to Students

- Students participating in the program shall gain:
- Early clarity on career paths through assessments and analytics.
- Hands-on exposure to hackathons, workshops, and real-world problem-solving.
- Industry-ready resumes and digital portfolios.
- Access to internships, mentoring, and professional networking.
- Recognition through institutional and platform-wide leaderboards.

## 8. Expected Outcomes

| Outcome Area | Derived Impact   |
|--------------|--|
| Students     | Improved career clarity, skill readiness, professional exposure, and employability indicators  |
| Institution  | Real-time analytics, data-driven training decisions, improved student engagement, and outcomes |

## 9. Duration of the MoU

This MoU shall be valid for the current academic year (2025-26) from the date of signing and may be extended by mutual written consent of both Parties.

## 10. Confidentiality

Both Parties agree to maintain the confidentiality of shared data, reports, and student information and ensure compliance with applicable data protection norms.

## **11. Financial & Payment Terms**

### **11.1 Student Strength & Program Fee**

I Year: 200 (Minimum) & II Year: 200 (Minimum)

The program fee shall be ₹ 1500 (Rupees Fifteen Hundred only) per student.

For selected/Interested students\*

### **11.2 Payment Mode**

Payments shall be collected through the Forge Alumnus Application or via an authorized online payment gateway enabled by Forge Alumnus.

### **11.3 Payment Responsibility**

The Institution shall facilitate student communication and onboarding to ensure timely payment completion by the enrolled students, as per the agreed scope.

### **11.4 Payment Timeline**

The last date for completing all payments shall be 31 March 2026 for II Years and 30 June 2026 for I Year students.

### **11.5 Access & Activation**

Student access to the Forge Alumnus digital ecosystem, including dashboards, hackathons, workshops, and related services, shall be activated upon successful payment confirmation.

## **12. Termination**

Either Party may terminate this MoU by providing 30 days' written notice to the other Party. Activities that have already commenced shall be completed as mutually agreed upon.

## **13. Non-Exclusivity**

This MoU is non-exclusive and does not restrict either Party from entering into similar collaborations with other organizations.

## **14. Governing Law**

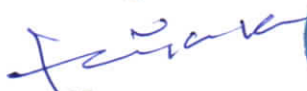

This MoU shall be governed and construed in accordance with the laws of India, and the courts of Karnataka shall have jurisdiction.

### 15. Acceptance

IN WITNESS WHEREOF, the Parties hereto have executed this Memorandum of Understanding on the date first written above.

IN WITNESS WHEREOF, the Parties hereto have executed this Master Service Agreement as of the Effective Date.

**Forge Alumnus Services Pvt. Ltd.**


Name: \_\_\_\_\_

Title: \_\_\_\_\_

Signature: \_\_\_\_\_

Date: \_\_\_\_\_

**CMR Technical Campus**

  
Name: \_\_\_\_\_  
Title: **Dr. A. RAJI REDDY**  
Signature: **Director**  
Date: **CMR Technical Campus**  
**Kandlakoya (V), Medchal Road,**  
**Hyderabad, Telangana - 501401.**